# MI0805K400R-10

#### **UNCONTROLLED DOCUMENT**

#### PHYSICAL DIMENSIONS:

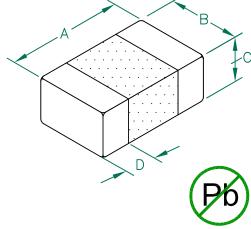
A 2.00 [.079] ± 0.20 [.008]

± 0.20 [.008] B 1.25 [.049]

0.90 [.035] ± 0.20 [.008]

0.51 [.020] ± 0.25 [.010]

> Z vs FREQUENCY IMPEDANCE UNDER DC BIAS



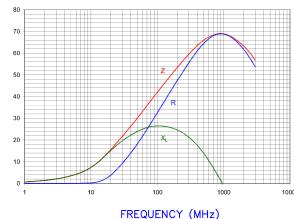
ELECTRICAL CHARACTERISTICS:											
Z @ 100MHz ( Ω )		DCR (Ω)	Rated Current								
Nominal	40										
Minimum	30										
Maximum	50	0.050	1500 mA								

NOTES: UNLESS OTHERWISE SPECIFIED

- 1. TAPED AND REELED per CURRENT EIA SPECIFICATIONS 7" REELS, 4000 PCS/REEL, PAPER TAPE.
- 2. COMPONENTS SHOULD BE ADEQUATELY PREHEATED BEFORE SOLDERING.
- 3. TERMINATION FINISH IS 100% TIN.
- 4. OPERATING TEMP. RANGE: -40°C~+125°C. (INCLUDING SELF-HEATING)

## 70 - 250ma - 500ma IMPEDANCE - 750ma 1000ma FREQUENCY (MHz)

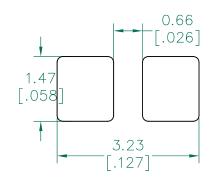
#### |Z| , R, AND X vs. FREQUENCY



AGILENT E4991A RF Impedance/Material Analyzer HP 16194A Test Fixture. TEST REF. 3227

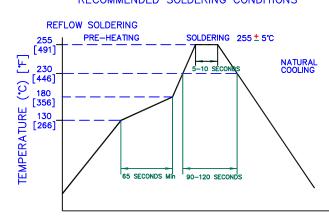
MPEDANCE

#### LAND PATTERNS FOR REFLOW SOLDERING



(For wave soldering, add 0.763 [.030] to this dimension.)

#### RECOMMENDED SOLDERING CONDITIONS



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DIMENSIONS ARE IN mm [INCHES].			This print is the property of Laird									
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				copies shall be made without th written consent of Laird Tech. A	FAIIA							
				rights to design or invention are reserved.								
D	ADD OPERATING TEMPERATURE	08/05/13	QU	PROJECT/PART NUMBER:	F	EV	PART TY	PE:	DRAWN BY:			
	UPDATE LAIRD LOGO AND REFLOW CURVE			MI0805K400R-10		D	CO-FIRE		JRK			
O	CHANGE TO PAPER TAPE	03/04/10	JUN	WIGOCOR TOOK TO		_	"		""			
æ	UPDATE COMPANY LOGO & ADD ROHS	08/06/08		I ()5/11/()4 I	SCAL	NTS		SHEET:				
Α	ORIGINAL DRAFT	03/11/04	JRK		TOOL	OOL # _						
REV	DESCRIPTION	DATE	INT	MI0805K400R-10-D				2	of 2			

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Authorized Distributor

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